

75 A, 1200 V, Hyperfast Diode

The RHRG75120 is a hyperfast diode with soft recovery characteristics. It has the half recovery time of ultrafast diodes and is silicon nitride passivated ionimplanted epitaxial planar construction. These devices are intended to be used as freewheeling/ clamping diodes and diodes in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Ordering Information

PART NUMBER	PACKAGE	BRAND
RHRG75120	TO-247-2L	RHRG75120

NOTE: When ordering, use the entire part number.

Symbol



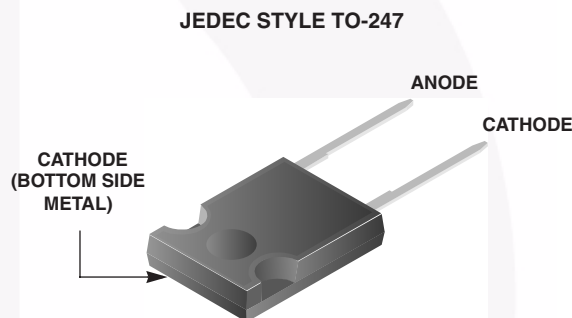
Features

- Hyperfast Recovery $t_{rr} = 100$ ns (@ $I_F = 75$ A)
- Max Forward Voltage, $V_F = 3.2$ V (@ $T_C = 25^\circ\text{C}$)
- 1200 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Packaging



Absolute Maximum Ratings $T_C = 25^\circ\text{C}$

		RHRG75120	UNIT
Peak Repetitive Reverse Voltage	V_{RRM}	1200	V
Working Peak Reverse Voltage	V_{RWM}	1200	V
DC Blocking Voltage	V_R	1200	V
Average Rectified Forward Current	$I_{F(AV)}$	75	A
($T_C = 42^\circ\text{C}$)			
Repetitive Peak Surge Current	I_{FRM}	150	A
(Square Wave, 20 kHz)			
Nonrepetitive Peak Surge Current	I_{FSM}	500	A
(Halfwave, 1 Phase, 60 Hz)			
Maximum Power Dissipation	P_D	190	W
Avalanche Energy (See Figures 7 and 8)	E_{AVL}	50	mJ
Operating and Storage Temperature	T_{STG}, T_J	-65 to 175	$^\circ\text{C}$

Electrical Specifications $T_C = 25^\circ\text{C}$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
V_F	$I_F = 75\text{ A}$	-	-	3.2	V
	$I_F = 75\text{ A}, T_C = 150^\circ\text{C}$	-	-	2.6	V
I_R	$V_R = 1200\text{ V}$	-	-	250	μA
	$V_R = 1200\text{ V}, T_C = 150^\circ\text{C}$	-	-	2	mA
T_{rr}	$I_F = 1\text{ A}, dI_F/dt = 100\text{ A}/\mu\text{s}$	-	-	85	ns
	$I_F = 75\text{ A}, dI_F/dt = 100\text{ A}/\mu\text{s}$	-	-	100	ns
t_a	$I_F = 75\text{ A}, dI_F/dt = 100\text{ A}/\mu\text{s}$	-	60	-	ns
t_b	$I_F = 75\text{ A}, dI_F/dt = 100\text{ A}/\mu\text{s}$	-	25	-	ns
$R_{\theta JC}$		-	-	0.8	$^\circ\text{C}/\text{W}$

DEFINITIONS

V_F = Instantaneous forward voltage ($p_w = 300\text{ }\mu\text{s}$, $D = 2\%$).

I_R = Instantaneous reverse current.

T_{rr} = Reverse recovery time (See Figure 6), summation of $t_a + t_b$.

t_a = Time to reach peak reverse current (See Figure 6).

t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 6).

$R_{\theta JC}$ = Thermal resistance junction to case.

p_w = Pulse width.

D = Duty cycle.

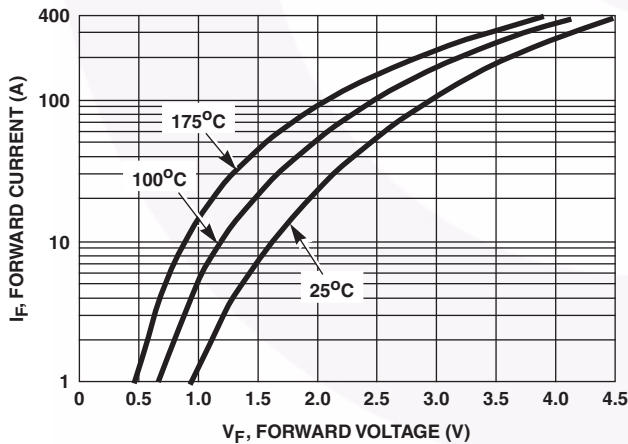
Typical Performance Curves

FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

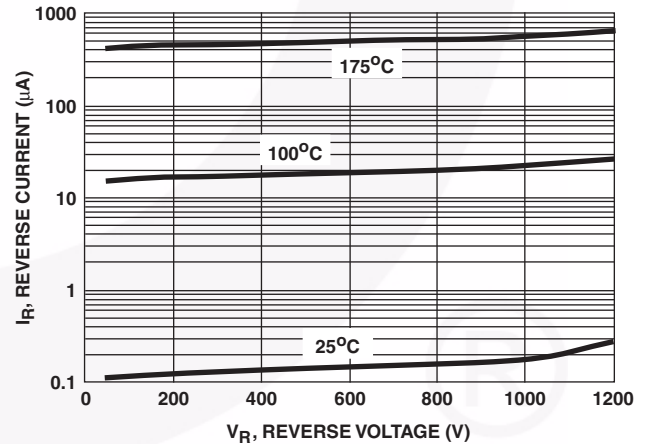


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

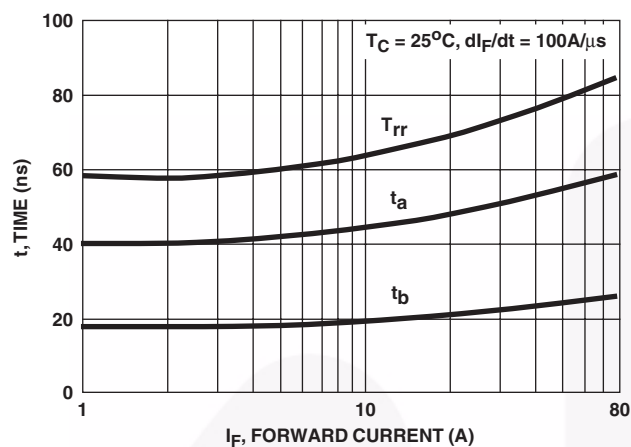
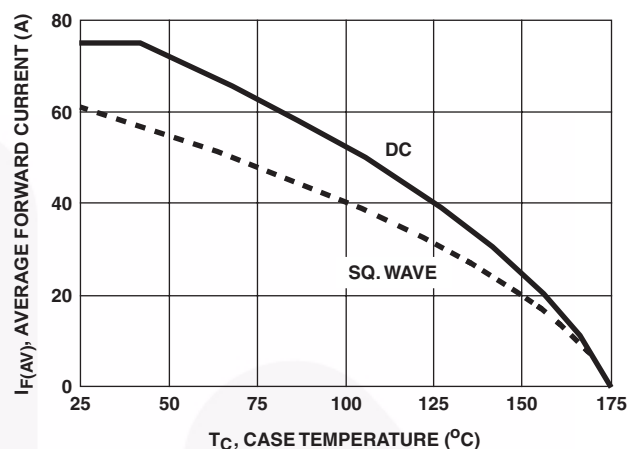
FIGURE 3. T_{rr} , t_a AND t_b CURVES vs FORWARD CURRENT

FIGURE 4. CURRENT DERATING CURVE

Test Circuits and Waveforms

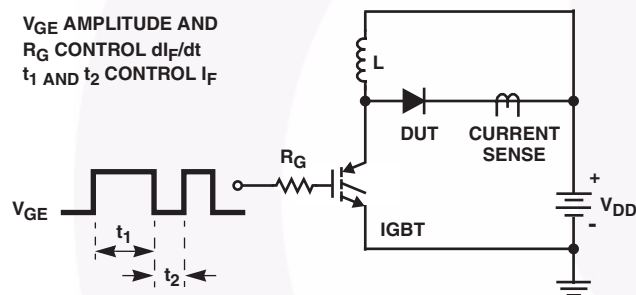
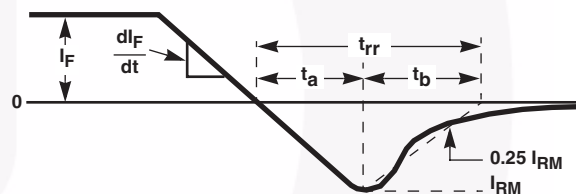
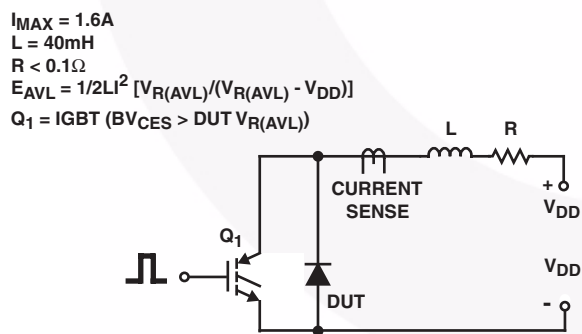
FIGURE 5. T_{rr} TEST CIRCUITFIGURE 6. T_{rr} WAVEFORMS AND DEFINITIONS

FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

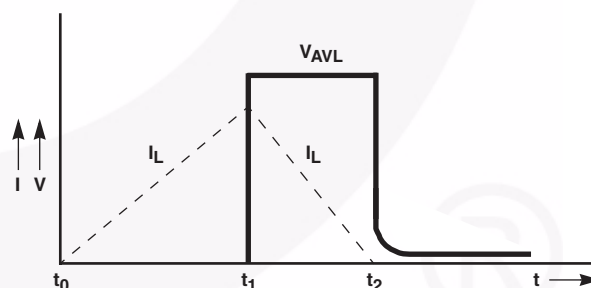
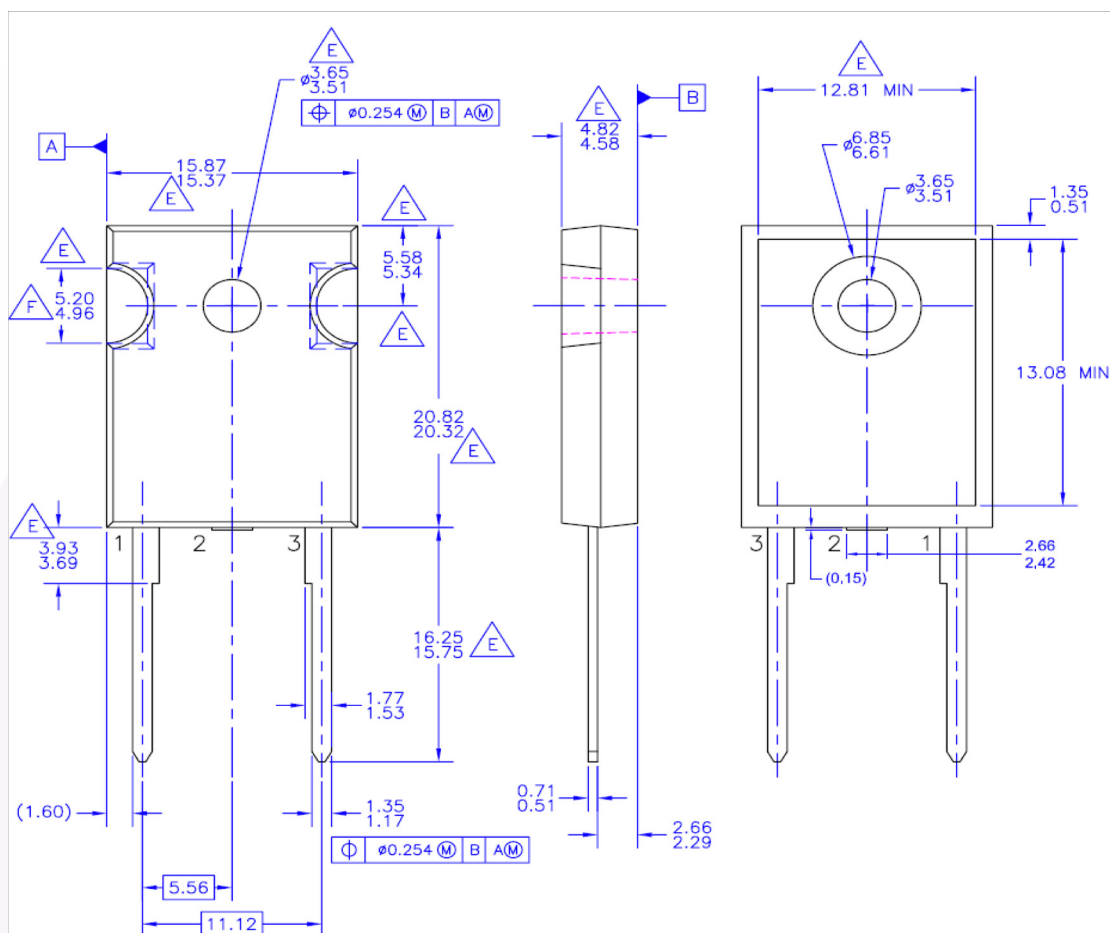


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Mechanical Dimensions

TO247-2L



- NOTES: UNLESS OTHERWISE SPECIFIED
- A. PACKAGE REFERENCE: JEDEC TO-247, ISSUE E, VARIATION AB, DATED JUNE, 2004.
 - B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
 - C. ALL DIMENSIONS ARE IN MILLIMETERS.
 - D. DRAWING CONFORMS TO ASME Y14.5 - 1994
 - E. DOES NOT COMPLY JEDEC STANDARD VALUE
 - F. NOTCH MAY BE SQUARE
 - G. DRAWING FILENAME: MKT-TO247B02_REV02

Figure 12. TO-247, Molded, 2LD, Jedec Option AB

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